

2.5 x 2.0 x 0.8mm Clipped Sinewave Output 13MHz to 52MHz

- Ultra-miniature SMD package 2.5 x 2.0 x 0.8mm
- Stability from ± 0.5 ppm over -20° to $+70^{\circ}$ C
- Supply Voltage 1.8V, 2.5V or 3.0Volts
- Miniature, lightweight and compact
- Ideal for portable devices such as GPS and handsets



SPECIFICATION

Product Series	M22S (Refer to VEM22S if voltage control function is required.)		
Output Wave Form:	Clipped Sine Wave		
Supply Voltage	1.8V \pm 5% (1.71V ~ 1.89V)	2.5V \pm 5% (2.37V ~ 2.62V)	3.0V \pm 5% (2.85V ~ 3.15V)
Frequency Range:	12.0MHz to 52.0MHz		
Initial Calibration Tolerance:	± 2 ppm maximum, $+25^{\circ}$ C, 1 hour after reflow		
Frequency Stability	From ± 0.5 ppm to ± 2.5 ppm over operating temperature range. Referenced to frequency reading at 25° C.		
vs Temperature:	See table below for availability		
vs Ageing:	± 1.0 ppm maximum, first year at 25° C		
vs Voltage Change:	± 0.2 ppm maximum for a $\pm 5\%$ voltage change		
vs Load Change:	± 0.2 ppm maximum for a $\pm 10\%$ load change		
vs Reflow:	± 1.0 ppm maximum for 1 reflow and measured after 24 hours		
Output Voltage Level (Peak to peak):	0.8V p-p min., 2.0V p-p max. Load 10k Ω //10pF $\pm 10\%$		
Output Format:	DC coupled. See below for output waveform. Requires an external AC-Coupling capacitor at pin 3, 1000pF recommended.		
Current Consumption:	fo < 26MHz: 2mA max. fo > 26MHz: 2.5mA max.		
Startup Time:	2ms max. (to reach 90% amplitude and at 25° C $\pm 2^{\circ}$ C)		
Packaging:	8.0mm tape; 4.0mm pitch; 180mm reel; 1000 pieces (code P1) or 3000 pieces (code P3) per reel. Cut tape for < 1k pieces.		

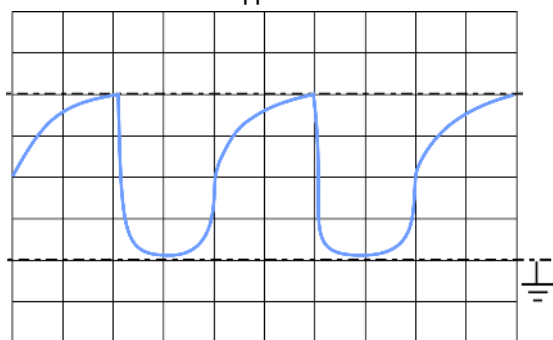
AVAILABLE FREQUENCY STABILITY vs OPERATING TEMPERATURE RANGE

Frequency Stability (ppm)		± 0.5	± 1.0	± 1.5	± 2.0	± 2.5
Temperature Range ($^{\circ}$ C)	0 ~ +50	✓	✓	✓	✓	✓
	-10 ~ +60	✓	✓	✓	✓	✓
	-20 ~ +70	✓	✓	✓	✓	✓
	-30 ~ +75	ASK	✓	✓	✓	STD
	-40 ~ +85	ASK	ASK	✓	✓	✓

✓ = available, STD = standard, ASK = call Technical Sales

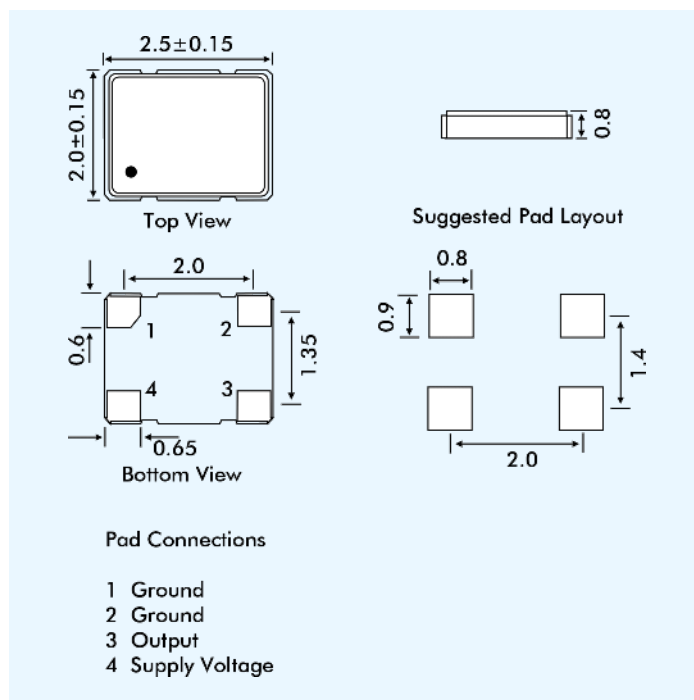
OUTPUT WAVEFORM

Waveform at Pin 3 - Clipped Sine Wave



Before AC-coupling capacitor

EM22S - OUTLINES AND DIMENSIONS



ENVIRONMENTAL PERFORMANCE SPECIFICATION

Environmental Approvals:	RoHS Compliant, Pb (lead) free, Free of Cadmium, Hexavalent Chromium, Lead, Mercury, PBBs and PBDEs
Moisture Sensitivity Test:	MSL = 1 per IPC/JEDEC J-STD-020D.1
Humidity:	85% RH, 85°C, 48 hours
Hermeticity, Fine Leak:	MIL-STD-883, method 1014, condition A
Hermeticity, Gross Leak:	MIL-STD-883, method 1014, condition C
Solderability:	MIL-STD-202F, method 208E
Vibration:	MIL-STD-883, method 2007, condition A, 10~2000Hz, 1.52mm 20g, each axis for 4 hours
Mechanical Shock:	MIL-STD-883, method 2002, condition B, 1500g, 1/2 sine, 0.5ms, each axis 3 times
Resistance to Solvent:	MIL-STD-202, method 215
Resistance to Soldering Heat:	MIL-STD-202, method 210
Temperature Cycling:	MIL-STD-883, method 1010
Thermal Shock:	MIL-STD-883F, method 1011.9, Condition B -55~+125°C, 10 min soak time, 200 cycles
H.A.S.T. (Highly Accelerated Stress Test):	JESD22-A110
Storage Temperature Range:	-55° ~ +125°C
ESD Protection:	1.5kV min., human body model.
Solder Pad Surface Finish:	Gold (Au) (0.3~1.0µm) over nickel (Ni) (1.27~8.89µm)
Second Level Interconnect Category:	e4
Unit Weight:	0.12gm

PART NUMBERING PROCEDURE

